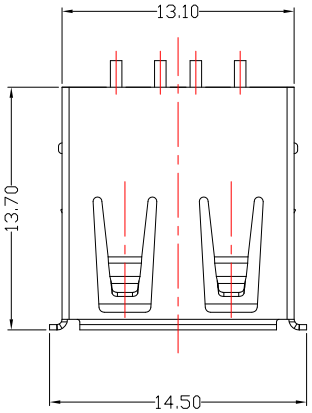


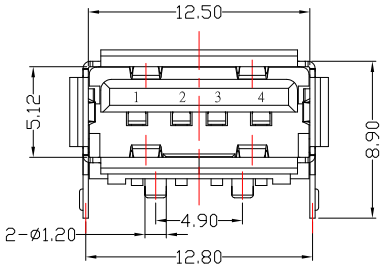
SUA-110M4x-x-S235

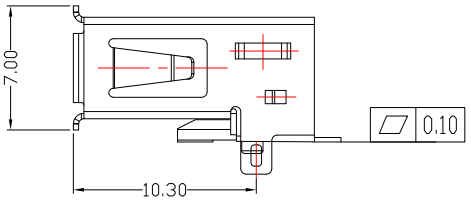
Shell Material :

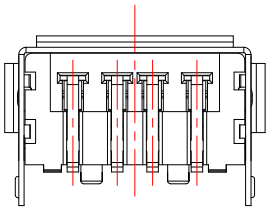
Blank : BRASS
I : SPCC

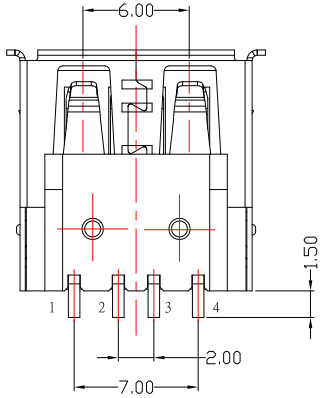
Color :

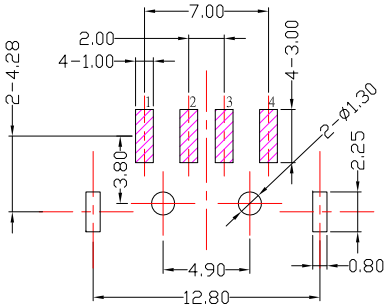
White : W
Black : B











RECOMMENDED PCB LAYOUT

SPECIFICATIONS

Electrical:

1.Contact Resistance: 30 mΩ Max

2.Insulation Resistance: 1,000 MΩ Min

3.Dielectric Withstanding Voltage: 500 V AC

Material:

1.Housing: LCP , UL 94V-0

2.Contact: Phosphor Bronze

3.Shell: Brass / SPCC

Finish:

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
3	新增PIN編號	Jack	072120
2	新增PCB LAYOUT尺寸	Jack	072020
1	新增平整度標示	Jack	052518

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

		DATE
DRAWN BY:	Jack Lu	07/21/20
CHECKED BY:	Jacky Chen	07/21/20
APPROVED BY:	Tony Kao	07/21/20

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	USB A/F SMT 外殼直腳 有柱
SCALE	1 : 1	DWG NO.	SUA-110M4x-x-S235
SHEET NO.	1 of 1	PART NO.	SUA-110M4x-x-S235

SIZE A4 | VER R3